SSCP80725GS6

High Frequency High Gain PNP Power BJT

➢ Features

VCB	VCE	VEB	IC
-50V	-45V	-5V	-0.5A

➢ Description

This device is produced with advanced high carrier density technology, which is especially used to minimize saturation voltage drop. This device particularly suits low voltage applications such as portable equipment, power management and other battery powered circuits, and low in-line power dissipation are needed in a very small outline surface mount package. Excellent thermal and electrical capabilities.

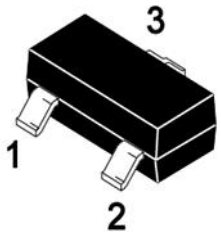
➢ Applications

- Supply line switching circuits
- Battery management application
- DC/DC converter applications

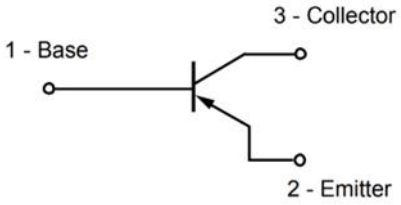
➢ Ordering Information

Device	Package	Shipping
SSCP80725GS6	SOT-23	3000/Reel

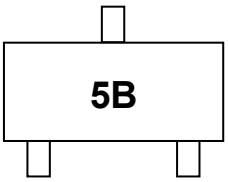
➢ Pin configuration



SOT-23



Circuit Diagram



Marking (Top View)

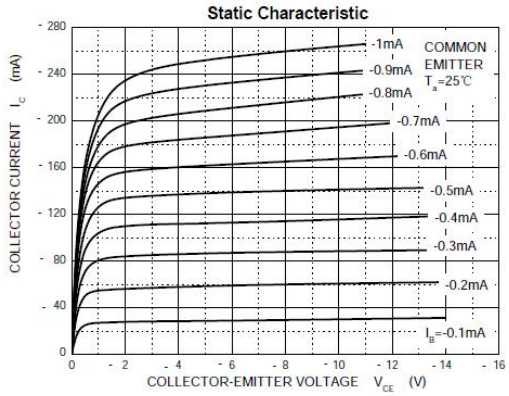
➢ Absolute Maximum Ratings(T_A=25℃ unless otherwise noted)

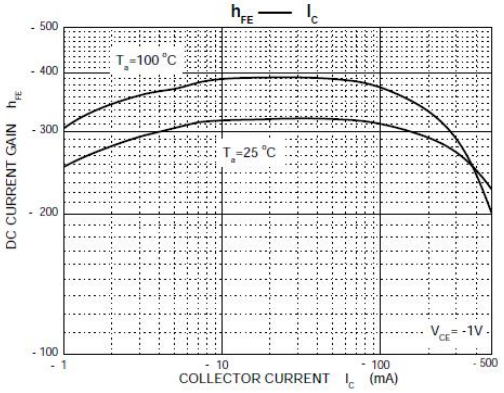
Parameter	Symbol	Value	Unit
Collector-Base Voltage	V_{CBO}	-50	V
Collector- Emitter Voltage	V_{CEO}	-45	V
Emitter-Base Voltage	V_{EBO}	-5	V
Collector Current-Continuous	I_C	-500	mA
Collector Power Dissipation	P_C	300	mW
Thermal resistance from junction to ambient	$R_{\theta JA}$	417	℃/W
Junction Temperature	T_J	150	℃
Storage Temperature	T_{STG}	-55 to 150	℃

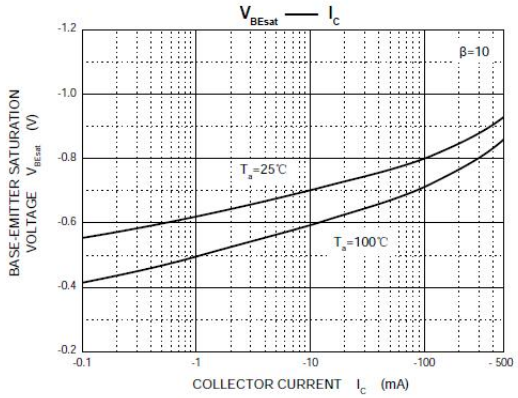
➢ Electrical Characteristics (T_A=25℃ unless otherwise noted)

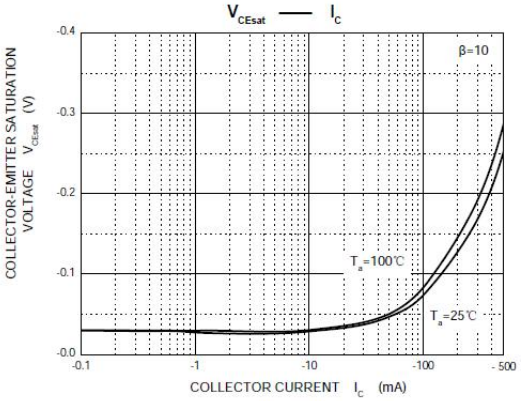
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Collector-Base Breakdown Voltage	BV_{CBO}	I_C=-10μA,I_E=0	-50			V
Collector-emitter Breakdown Voltage	BV_{CEO}	I_C=-10mA,I_B=0	-45			V
Emitter -Base Breakdown Voltage	BV_{EBO}	I_E=-1μA A,I_C=0	-5			V
Collector Cutoff Current	I_{CBO}	V_{CB}=-45V,I_E=0			-0.1	μA
Emitter Cutoff Current	I_{EBO}	V_{EB}=-4V,I_C=0			-0.1	μA
DC Current Gain	h_{FE}	V_{CE}=-1V,I_C=-100mA	160		400	
		V_{CE}=-1V,I_C=-500mA	40			
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	I_C=-500mA,I_B=-50mA			-0.7	V
Base-Emitter Saturation Voltage	$V_{BE(sat)}$	I_C=-500mA,I_B=-50mA			-1.2	V
Base-emitter Voltage	$V_{BE(ON)}$	V_{CE}=1V,I_C=500mA			1.2	V
Transition frequency	f_T	V_{CE}=-5V,I_C=-10mA f=100MHz	100			MHz

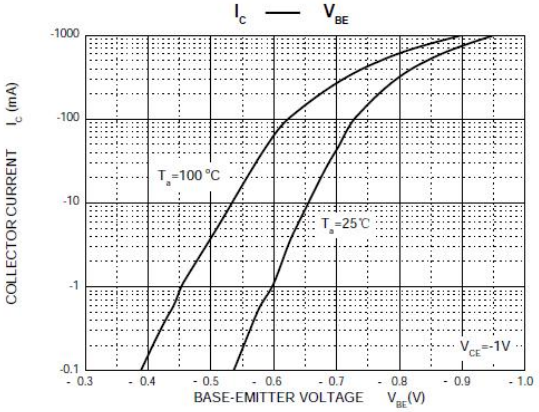
➢ Typical Performance Characteristics (T_A=25℃ unless otherwise noted)

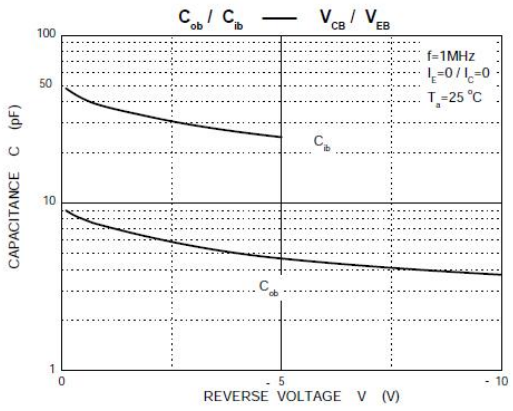


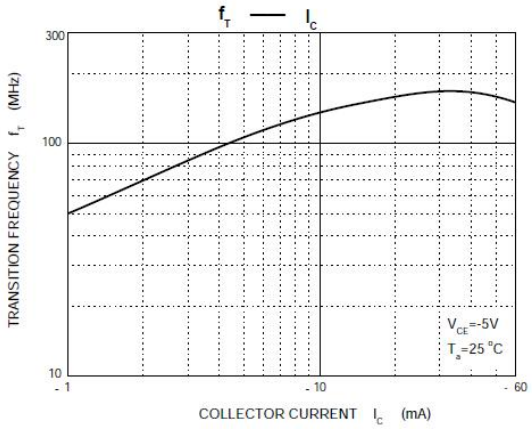


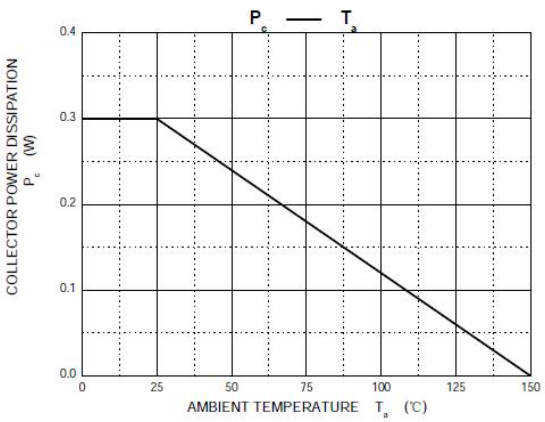




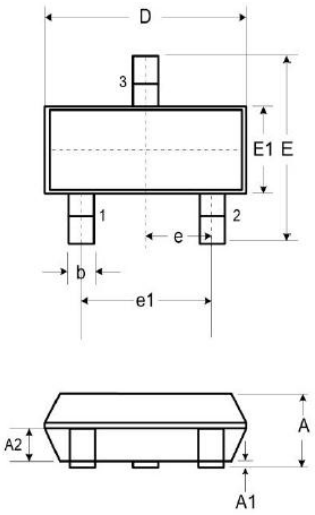


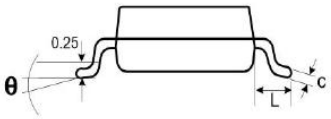






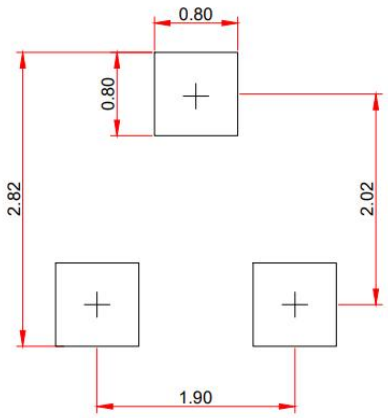
➢ Package Information





DIM	Millimeters		
	Min.	Typ.	Max.
A	0.89	-	1.12
A1	0.01	-	0.10
A2	0.88	0.95	1.02
b	0.30	-	0.51
c	0.08	-	0.18
D	2.80	2.90	3.04
E	2.10	2.37	2.64
E1	1.20	1.30	1.40
e	0.95		
e1	1.90		
L	0.40	0.50	0.60
L1	0.55		
N	3		
θ	0°	-	8°

Recommended Pad outline (Unit: mm)



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